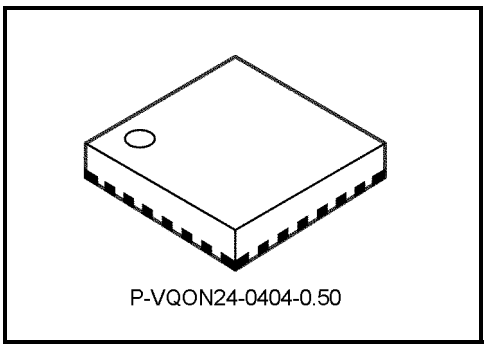
TOSHIBA Bipolar Linear IC Silicon Monolithic

TA2170FTG

Low Current Consumption Headphone Amplifier (Built-in input selector)

The TA2170FTG is a stereo headphone amplifier built in the selector switch of 3 inputs.

The mute switch is built in each 3 input, and an output can choose 1 output or a mixer output.



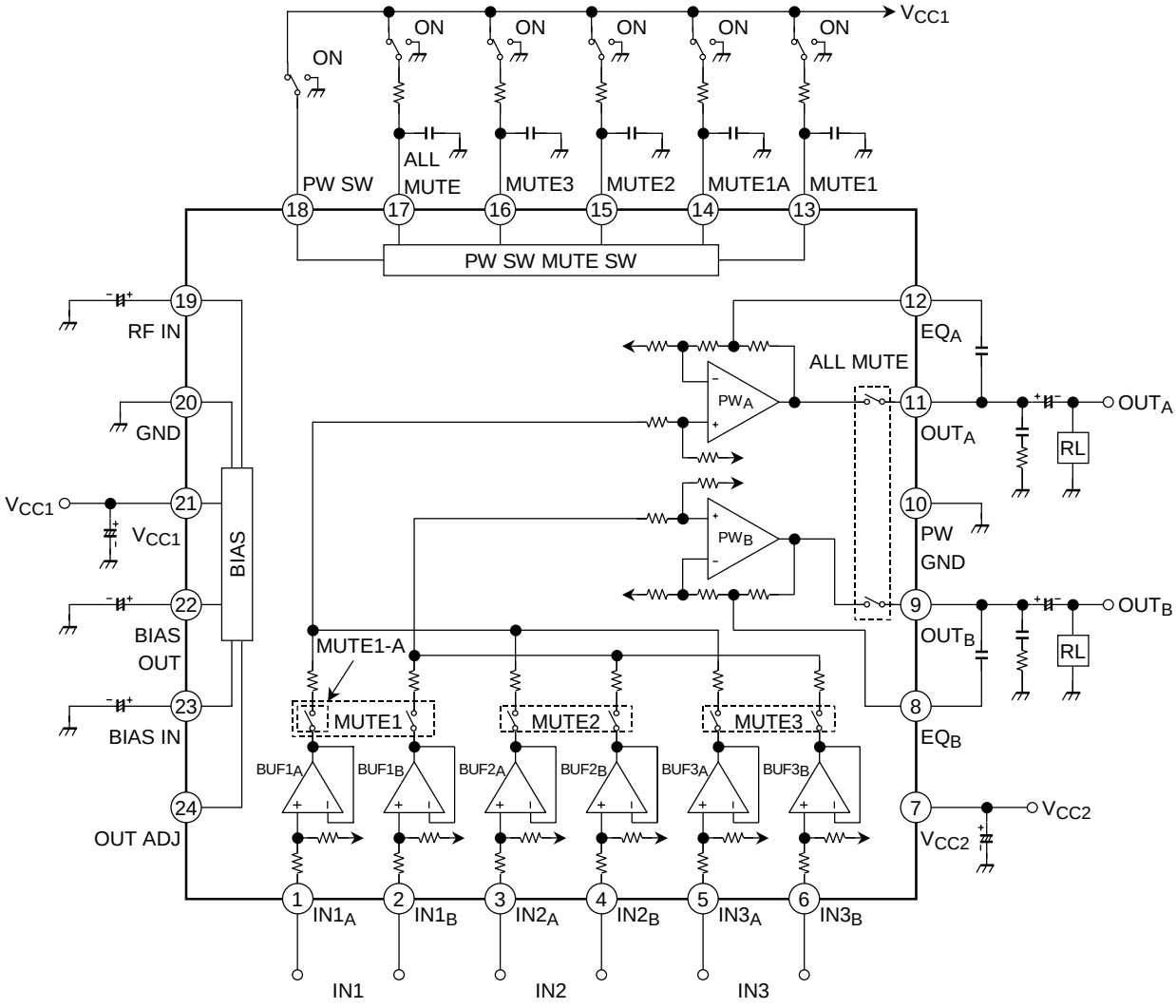
Weight: 0.03 g (typ.)

Marking: 2170

Features

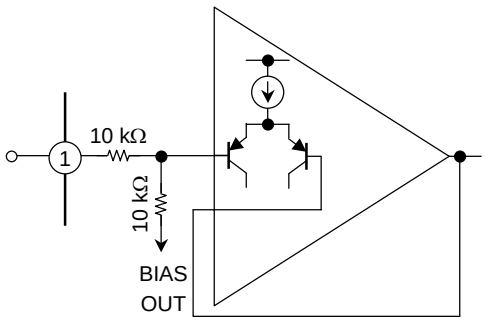
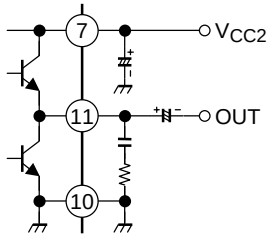
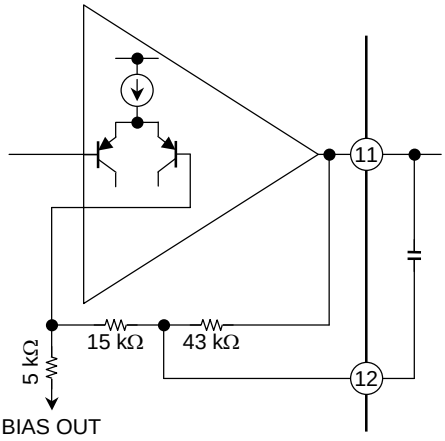
- Low current consumption
  V_{CC} = 3 V, f = 1 kHz, R_L = 32 Ω, typ.
  - No signal mode
    I_{CCQ} = 0.9 mA (1 input mode)
    I_{CCQ} = 1.0 mA (2 inputs mode)
    I_{CCQ} = 1.1 mA (3 inputs mode)
  - 0.1 mW × 2 ch
    I_{CC} = 2.2 mA (1 input mode)
    I_{CC} = 2.3 mA (2 inputs mode)
    I_{CC} = 2.4 mA (3 inputs mode)
  - 0.5 mW × 2 ch
    I_{CC} = 4.1 mA (1 input mode)
    I_{CC} = 4.2 mA (2 inputs mode)
    I_{CC} = 4.3 mA (3 inputs mode)
- G_V = −0.3dB (1 input mode, typ.)
- Built-in signal level adjustment circuit, so that a 1 output or a mixer output doesn't change a feeling of volume either.
- Built-in power switch
- Built-in all mute switch
- Built-in mute switch at each buffer amplifier.
- Built-in one side mute switch at buffer amplifier 1.
- Operating supply voltage range (Ta = 25°C): $V_{CC1\ (opr)}$ = 1.8 to 4.5 V
  $V_{CC2\ (opr)}$ = 0.9 to 4.5 V

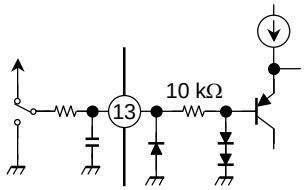
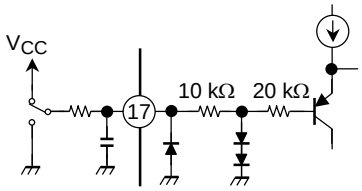
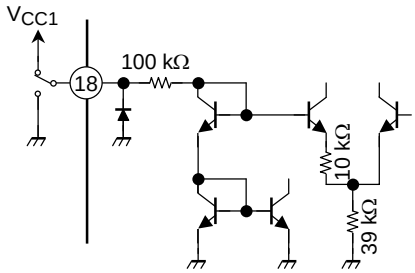
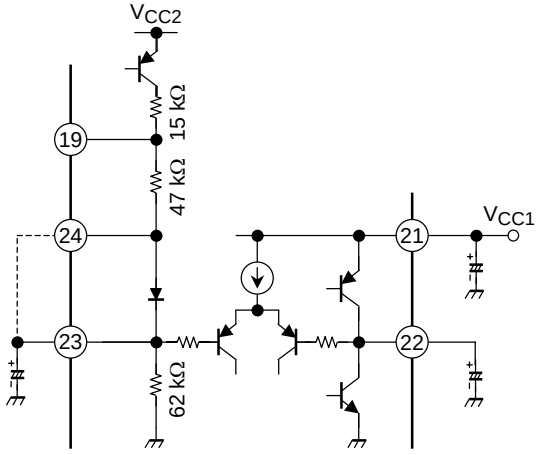
Block Diagram



Pin Descriptions

Pin Voltage: Typical Pin voltage for test circuit when no input signal is applied, $V_{CC1} = V_{CC2} = 3$ V, Ta = 25°C

Pin No. and Name		Function	Internal Circuit	Pin Voltage (V)
1	$IN1_A$	Inputs to buffer amplifier 1		1.15
2	$IN1_B$			
3	$IN2_A$	Inputs to buffer amplifier 2		1.15
4	$IN2_B$			
5	$IN3_A$	Inputs to buffer amplifier 3		1.15
6	$IN3_B$			
7	V_{CC2}	V_{CC} for power drive stage		3
9	OUT_B	Outputs from power amplifier		1.15
11	OUT_A			
10	PW GND	GND for power drive stage		0
8	EQ_B	Low-pass Compensation pins		1.15
12	EQ_A			

Pin No. and Name		Function	Internal Circuit	Pin Voltage (V)
13	MUTE1	Mute switch of buffer amplifier 1 (Mute ON : L level Mute OFF: H level Refer to application note 4.		—
14	MUTE1A	Mute switch of buffer amplifier 1A (Mute ON : L level Mute OFF: H level this switch is used when it turn on A channel mutes of a buffer amplifier 1. Refer to application note 4.		—
15	MUTE2	Mute switch of buffer amplifier 2 (Mute ON : L level Mute OFF: H level Refer to application note 4.		—
16	MUTE3	Mute switch of buffer amplifier 3 (Mute ON : L level Mute OFF: H level Refer to application note 4.		—
17	ALL MUTE	All mute switch (Mute ON : L level Mute OFF: H level Refer to application note 4.		—
18	PW SW	Power switch (IC ON : H level IC OFF: L level Refer to application note 4.		3
19	RF IN	Ripple filter input		2.7
21	V_{CC1}	V_{CC} for everything other than power drive stage		3
22	BIAS OUT	Bias circuit output		1.15
23	BIAS IN	Bias circuit input		1.15
24	OUT ADJ	DC output voltage adjustment Either connect this pin or leave it open depending on the level of V_{CC2}. If the power supply of a 1.5 V system is applied to V_{CC2}, connect this pin to BIAS IN (pin14) If the power supply of a 3 V system is applied to V_{CC2}, leave this pin open.		1.85
20	GND	—	—	0

Application Notes

1. Mute switch and voltage gain

This IC is designed so that a volume feeling may not change with a single output and many outputs.
When the input signal to buffer amplifier is same and a linear domain, the relation between mute switches and voltage gain are as follows.

Test condition: V_{CC} = 3 V, f = 1 kHz, V_{in} = −20dBV, theoretical value

(1) 1 input mode

MUTE SW				Attenuation to an input signal (dB)						Total gain (dB)	
				BUF1		BUF2		BUF3			
MUTE1	MUTE1A	MUTE2	MUTE3	Ach	Bch	Ach	Bch	Ach	Bch	Ach	Bch
Input signal is applied to BUF 1.											
OFF	OFF	ON	ON	0	0	—	—	—	—	0	0
OFF	OFF	OFF	ON	−6	−6	—	—	—	—	−6	−6
OFF	OFF	ON	OFF	−6	−6	—	—	—	—	−6	−6
OFF	OFF	OFF	OFF	−9.5	−9.5	—	—	—	—	−9.5	−9.5
OFF	ON	ON	ON	—	0	—	—	—	—	—	0
OFF	ON	OFF	ON	—	−6	—	—	—	—	—	−6
OFF	ON	ON	OFF	—	−6	—	—	—	—	—	−6
OFF	ON	OFF	OFF	—	−9.5	—	—	—	—	—	−9.5
Input signal is applied to BUF 2											
ON	ON/OFF	OFF	ON	—	—	0	0	—	—	0	0
ON	ON/OFF	OFF	OFF	—	—	−6	−6	—	—	−6	−6
OFF	OFF	OFF	ON	—	—	−6	−6	—	—	−6	−6
OFF	ON	OFF	ON	—	—	0	−6	—	—	0	−6
OFF	OFF	OFF	OFF	—	—	−9.5	−9.5	—	—	−9.5	−9.5
OFF	ON	OFF	OFF	—	—	−6	−9.5	—	—	−6	−9.5
Input signal is applied to BUF 3.											
ON	ON/OFF	ON	OFF	—	—	—	—	0	0	0	0
ON	ON/OFF	OFF	OFF	—	—	—	—	−6	−6	−6	−6
OFF	OFF	ON	OFF	—	—	—	—	−6	−6	−6	−6
OFF	ON	ON	OFF	—	—	—	—	0	−6	0	−6
OFF	OFF	OFF	OFF	—	—	—	—	−9.5	−9.5	−9.5	−9.5
OFF	ON	OFF	OFF	—	—	—	—	−6	−9.5	−6	−9.5

(2) 2 inputs mode

MUTE SW				Attenuation to an input signal (dB)						Total gain (dB)	
				BUF1		BUF2		BUF3			
MUTE1	MUTE1A	MUTE2	MUTE3	Ach	Bch	Ach	Bch	Ach	Bch	Ach	Bch
Input signal is applied to BUF 1 and BUF 2.											
OFF	OFF	OFF	ON	−6	−6	−6	−6	—	—	0	0
OFF	OFF	OFF	OFF	−9.5	−9.5	−9.5	−9.5	—	—	−3.5	−3.5
OFF	ON	OFF	ON	—	—	—	—	—	—	—	—
OFF	ON	OFF	OFF	—	−6	−9.5	−6	—	—	−3.5	0
Input signal is applied to BUF 1 and BUF 3.											
OFF	OFF	ON	OFF	−6	−6	—	—	−6	−6	0	0
OFF	OFF	OFF	OFF	−9.5	−9.5	—	—	−9.5	−9.5	−3.5	−3.5
OFF	ON	ON	OFF	—	−6	—	—	−6	−6	−6	0
OFF	ON	OFF	OFF	—	−9.5	—	—	−9.5	−9.5	−9.5	−3.5
Input signal is applied to BUF 2 and BUF 3.											
ON	ON/OFF	OFF	OFF	—	—	−6	−6	−6	−6	0	0
OFF	ON	OFF	OFF	—	—	−6	−9.5	−6	−9.5	0	−3.5
OFF	OFF	OFF	OFF	—	—	−9.5	−9.5	−9.5	−9.5	−3.5	−3.5

(3) 3 inputs mode

MUTE SW				Attenuation to an input signal (dB)						Total gain (dB)	
				BUF1		BUF2		BUF3			
MUTE1	MUTE1A	MUTE2	MUTE3	Ach	Bch	Ach	Bch	Ach	Bch	Ach	Bch
OFF	OFF	OFF	OFF	−9.5	−9.5	−9.5	−9.5	−9.5	−9.5	0	0
OFF	ON	OFF	OFF	—	−9.5	−9.5	−9.5	−9.5	−9.5	−3.5	0

2. Low-cut compensation

The low-frequency range can be decreased using an output-coupling capacitor and a load (f_c = 50 Hz at C = 100 μF, R = 32 Ω). However, since the capacitor is connected between the IC's output pin (pin 9/11) and EQ pin (pin 8/12), the low-frequency gain of the power amplifier increases, enabling low-cut compensation to be performed. For the response of capacitors of different values, please refer to Figure 1.

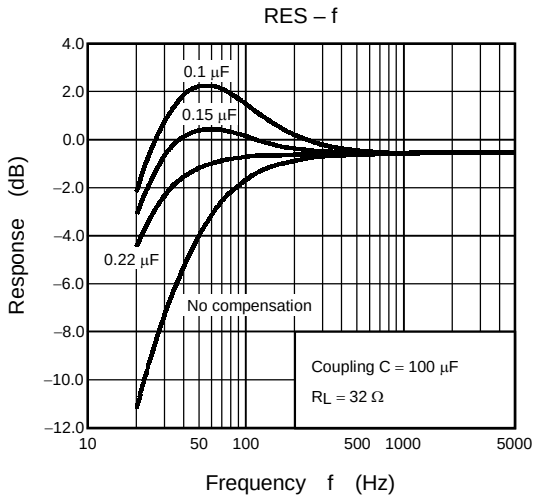


Figure 1 Capacitor response

3. Adjustment of DC output voltage

Please perform the OUT ADJ pin (pin 24) as follows by the power supply of V_{CC1} and V_{CC2}.

- If a boost voltage is applied to V_{CC1}, V_{CC2} is connected to a battery and the difference between V_{CC1} and V_{CC2} is greater than or equal to 0.7 V, short pins 23 and 24 together. In this case the DC output voltage

  will be $\frac{V_{CC2}}{2}$.

- If the difference between V_{CC1} and V_{CC2} is less than 0.7 V, or if V_{CC1} and V_{CC2} are connected to the same power supply, leave pin 24 open.

  In these cases the DC output voltage will be $\frac{V_{CC2} - 0.7\ V}{2}$.

4. Switch

(1) Timing chart
Refer to Fig. 2 for the IC timing chart.

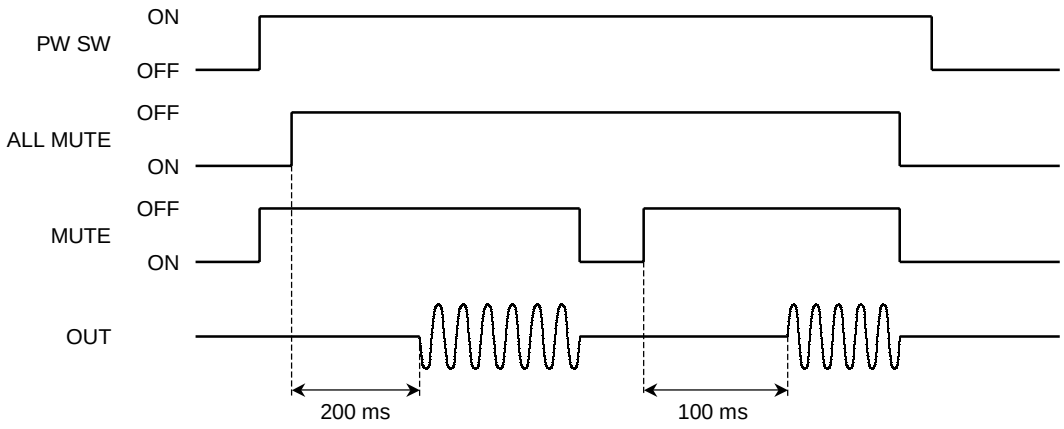
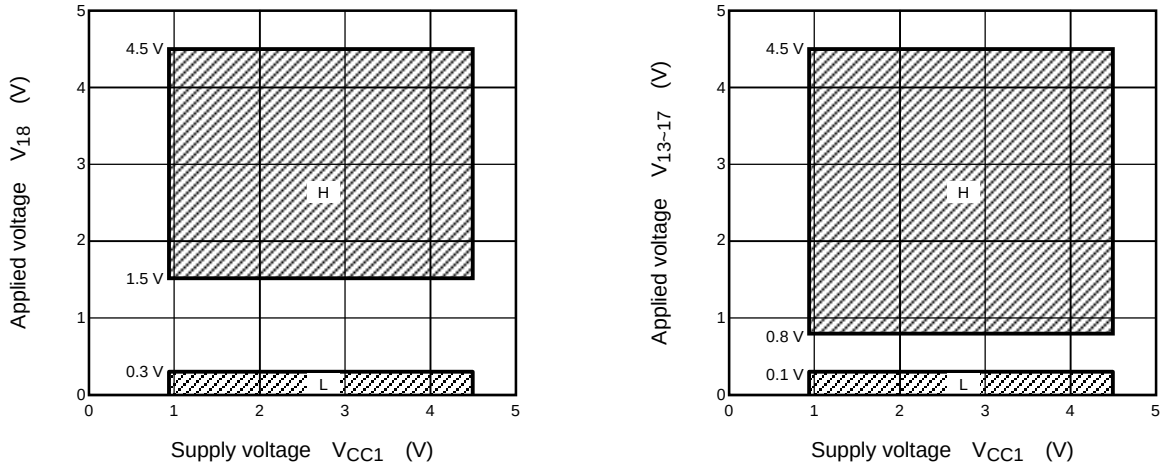


Figure 2 Timing chart

(2) PW SW
The device is ON when this pin is set to High. To prevent the IC being turned ON by external noise, it is necessary to connect an external pull-down resistor to the PW SW pin. The pin is highly sensitive.

(3) Mute smoothing
The resistor is connected to a mute pin less than 100 kΩ
When larger than this, the switch circuit doesn't operate normally.

(4) Switch sensitivity (Ta = 25°C)



	PW SW
H level	IC ON
L level	IC OFF

	MUTE
H level	Mute OFF
L level	Mute ON

Figure 3 Switch sensitivity

5. Capacitor

The following capacitors must have excellent temperature and frequency characteristics.

Absolute Maximum Ratings (Ta = 25°C)

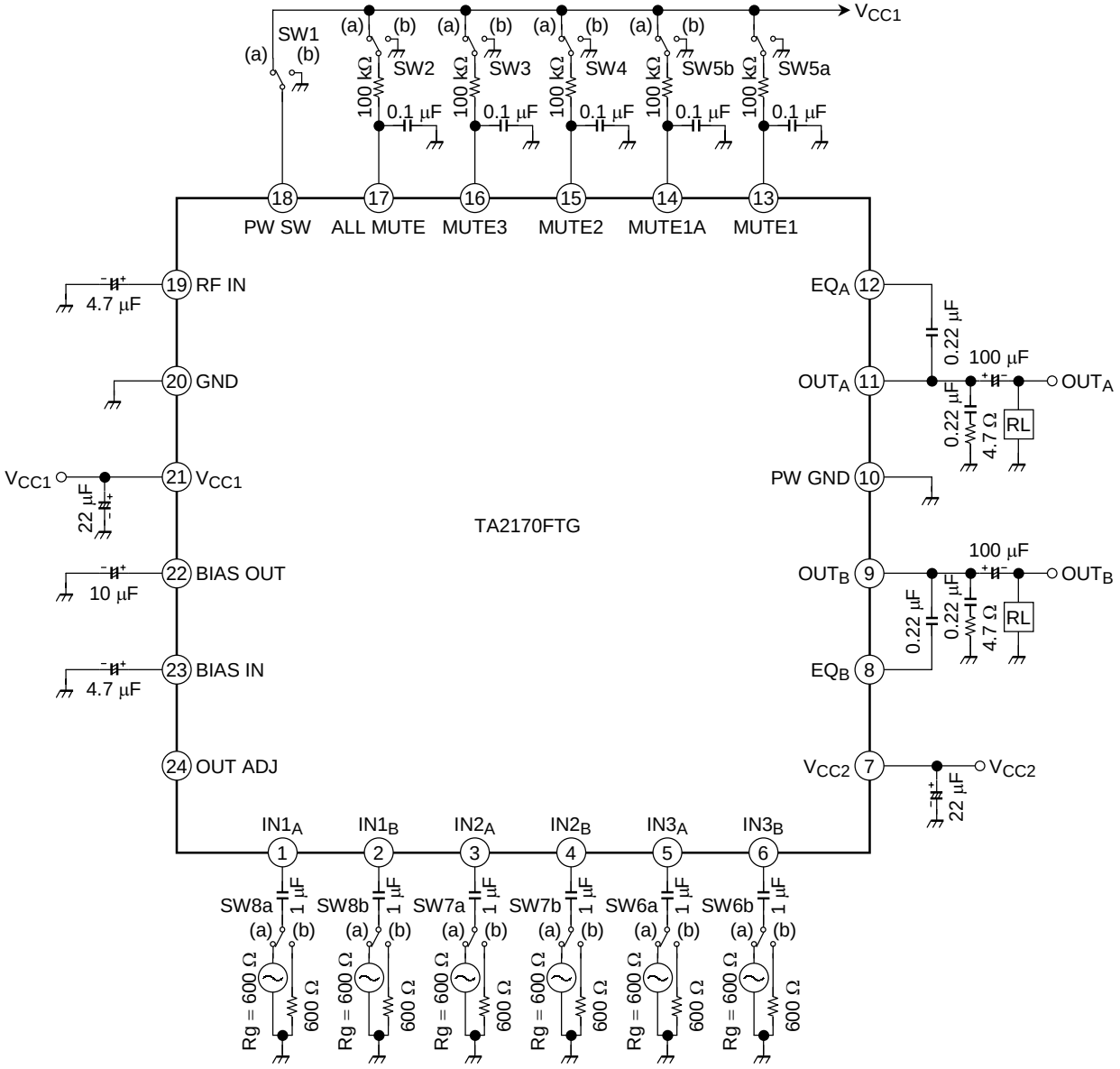
Characteristic	Symbol	Rating	Unit
Supply voltage 1	V_{CC1}	4.5	V
Supply voltage 2	V_{CC2}	4.5	
Output current	$I_{o\ (peak)}$	100	mA
Power dissipation	P_D (Note)	350	mW
Operating temperature	T_{opr}	−25~75	°C
Storage temperature	T_{stg}	−55~150	°C

Note: Derated by 2.8 mW/°C above Ta = 25°C

Electrical Characteristics (Unless otherwise specified, V_{CC1} = V_{CC2} = 3 V, Rg = 600 Ω, R_L = 32 Ω, f = 1 kHz, Ta = 25°C, SW1~SW5: a, SW6~SW8: a)

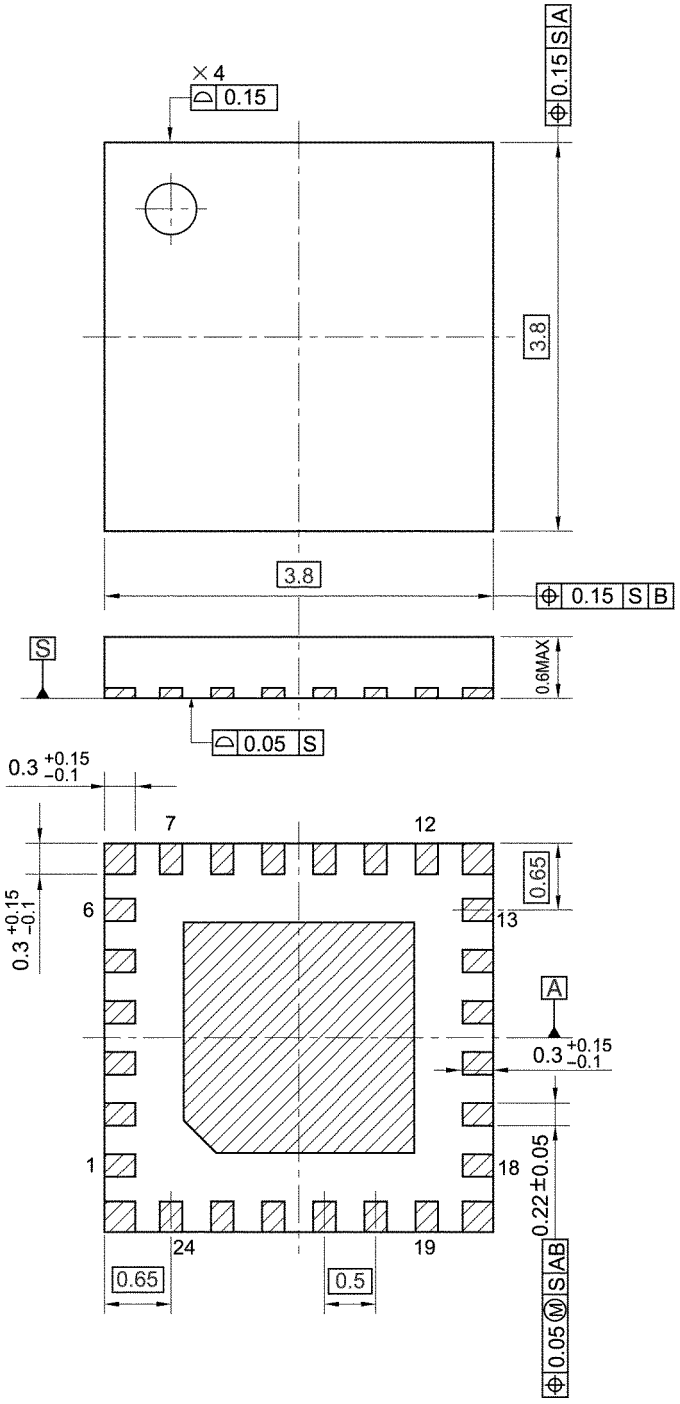
Characteristic	Symbol	Test condition	Min.	Typ.	Max.	Unit
Quiescent supply current	I_{CCQ1}	IC OFF mode SW1~5: b	—	—	5	μA
	I_{CCQ2}	1 input on mode BUF1: ON (SW5: a, SW3/4: b) BUF2: ON (SW4: a, SW3/5: b) BUF3: ON (SW3: a, SW4/5: b)	—	0.9	1.6	mA
	I_{CCQ3}	2 input on mode BUF1/2: ON (SW4/5: a, SW3: b) BUF1/3: ON (SW3/5: a, SW4: b) BUF2/3: ON (SW3/4: a, SW5: b)	—	1.0	1.8	
	I_{CCQ4}	3 input on mode	—	1.1	2.0	
	I_{CCQ5}	1 input on mode V_{CC1} = 2.4 V, V_{CC2} = 1.2 V BUF1: ON (SW5: a, SW3/4: b) BUF2: ON (SW4: a, SW3/5: b) BUF3: ON (SW3: a, SW4/5: b)	—	0.9	1.6	
Power supply current during drive	I_{CC1}	1 input on mode 0.1 mW/32 Ω × 2 ch BUF1: ON (SW5: a, SW3/4: b) BUF2: ON (SW4: a, SW3/5: b) BUF3: ON (SW3: a, SW4/5: b)	—	2.2	—	mA
	I_{CC2}	2 input on mode 0.1 mW/32 Ω × 2 ch BUF1/2: ON (SW4/5: a, SW3: b) BUF1/3: ON (SW3/5: a, SW4: b) BUF2/3: ON (SW3/4: a, SW5: b)	—	2.3	—	
	I_{CC3}	3 input on mode 0.1 mW/32 Ω × 2 ch	—	2.4	—	
Voltage gain	G_{V1}	1 input on mode V_o = −20dBV BUF1: ON (SW5: a, SW3/4: b) BUF2: ON (SW4: a, SW3/5: b) BUF3: ON (SW3: a, SW4/5: b)	−1.8	−0.3	1.2	dB
	G_{V2}	2 input on mode V_o = −20dBV BUF1/2: ON (SW4/5: a, SW3: b) BUF1/3: ON (SW3/5: a, SW4: b) BUF2/3: ON (SW3/4: a, SW5: b)	−1.0	0.5	2.0	
	G_{V3}	3 input on mode V_o = −20dBV	−0.8	0.7	2.2	
Channel balance	CB	V_o = −20dBV	−1.5	0	1.5	dB
Output power	P_{o1}	THD = 10%	15	20	—	mW
	P_{o2}	V_{CC1} = 2.4 V, V_{CC2} = 1.2 V THD = 10%	3	6	—	
Total harmonic distortion	THD	P_o = 1 mW	—	0.1	0.3	%
Output noise voltage	V_{no}	R_g = 600 Ω, Filter: IHF-A, SW6~8: b	—	−100	−96	dBV
Cross talk	CT	V_o = −20dBV	−53	−60	—	dB
Ripple rejection ratio	RR	f_r = 100 Hz, V_r = −20dBV	−70	−80	—	dB
Muting attenuation	ATT1	ALL MUTE SW: ON, V_o = −20dBV	−75	−90	—	dB
	ATT2	MUTE SW: ON, V_o = −20dBV	−47	−62	—	
PW SW ON current	I19	V_{CC1} = 1.8 V, V_{CC2} = 0.9 V	5	—	—	μA
PW SW OFF voltage	V19	V_{CC1} = 1.8 V, V_{CC2} = 0.9 V	0	—	0.3	V
MUTE SW OFF current	I_{20-24}	V_{CC1} = 1.8 V, V_{CC2} = 0.9 V	5	—	—	μA
MUTE SW ON voltage	V_{20-24}	V_{CC1} = 1.8 V, V_{CC2} = 0.9 V	0	—	0.1	V

Test Circuit



Package Dimensions

P-VQON24-0404-0.50 Unit: mm



Weight: 0.03 g (typ.)

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